

## CBR06C859B1GAC

CBR-SMD RF COG, Ceramic, 8.5 pF, +/-0.1 pF, 100 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
Т	0.8mm +/-0.07mm
В	0.4mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	5.6 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

8.5 pF
+/-0.1 pF
100 VDC
250 VDC
-55/+125°C
COG
0.175%
0% Loss/Decade Hour
10 GOhms
570

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